



STPS61L60C

Power Schottky rectifier

Features

- High current capability
- Avalanche rated
- Low forward voltage drop current
- High frequency operation

Description

Dual center tap schottky rectifier suited for high frequency switch mode power supplies.

Packaged in TO-247 and TO-220AB, this device provides desktop SMPS designers with a low forward voltage drop device, and reduced leakage current, with the objective of making the application compliant with environmental care standards, or suitable for 80+ requirements.

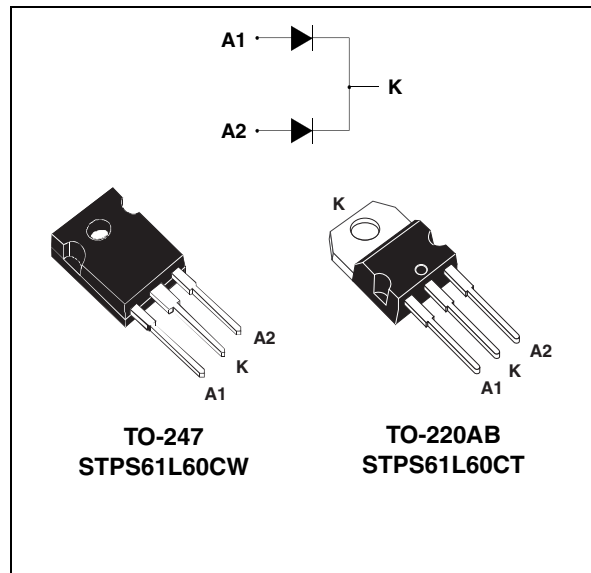


Table 1. Device summary

$I_{F(AV)}$	2 x 30 A
V_{RRM}	60 V
T_j (max)	150 °C
V_F (typ)	0.560 V

1 Characteristics

Table 2. Absolute ratings (limiting values per diode at 25 °C unless otherwise specified)

Symbol	Parameter		Value	Unit	
V_{RRM}	Repetitive peak reverse voltage		60	V	
$I_{F(RMS)}$	RMS forward current		50	A	
$I_{F(AV)}$	Average forward current $\delta = 0.5$	$T_c = 125\text{ °C}$ $T_c = 120\text{ °C}$	Per diode Per device	30 60	A
I_{FSM}	Surge non repetitive forward current	$t_p = 10\text{ ms}$ sinusoidal	TO-247 TO-220AB	530 400	A
P_{ARM}	Repetitive peak avalanche power	$t_p = 1\text{ }\mu\text{s}$ $T_j = 25\text{ °C}$		11500	W
T_{stg}	Storage temperature range		-65 to + 175	°C	
T_j	Maximum operating junction temperature ⁽¹⁾		150	°C	

1. $\frac{dP_{tot}}{dT_j} < \frac{1}{R_{th(j-a)}}$ condition to avoid runaway for a diode on its own heatsink

Table 3. Thermal resistances

Symbol	Parameter		Value	Unit	
$R_{th(j-c)}$	Junction to case	TO-247	Per diode Total	0.95 0.6	°C/W
		TO-220AB	Per diode Total	1.1 0.7	
$R_{th(c)}$	Coupling	TO-247		0.25	
		TO-220AB		0.3	

When the diodes 1 and 2 are used simultaneously :

$$\Delta T_j(\text{diode 1}) = P(\text{diode 1}) \times R_{th(j-c)}(\text{Per diode}) + P(\text{diode 2}) \times R_{th(c)}$$

Table 4. Static electrical characteristics (per diode)

Symbol	Parameter	Test conditions		Min.	Typ.	Max.	Unit
$I_R^{(1)}$	Reverse leakage current	$T_j = 25\text{ °C}$	$V_R = V_{RRM}$	-	-	0.8	mA
		$T_j = 125\text{ °C}$		-	150	350	
$V_F^{(2)}$	Forward voltage drop	$T_j = 25\text{ °C}$	$I_F = 5\text{ A}$	-	0.360	-	V
		$T_j = 125\text{ °C}$	$I_F = 5\text{ A}$	-	0.255	-	
		$T_j = 25\text{ °C}$	$I_F = 15\text{ A}$	-	0.460	0.540	
		$T_j = 125\text{ °C}$	$I_F = 15\text{ A}$	-	0.415	0.480	
		$T_j = 25\text{ °C}$	$I_F = 30\text{ A}$	-	0.580	0.660	
		$T_j = 125\text{ °C}$	$I_F = 30\text{ A}$	-	0.560	0.620	

1. Pulse test: $t_p = 5\text{ ms}$, $\delta < 2\%$

2. Pulse test: $t_p = 380\text{ }\mu\text{s}$, $\delta < 2\%$

To evaluate the conduction losses use the following equation:

$$P = 0.44 \times I_{F(AV)} + 0.006 \times I_{F(RMS)}^2$$

Figure 1. Average forward power dissipation vs. average forward current (per diode)

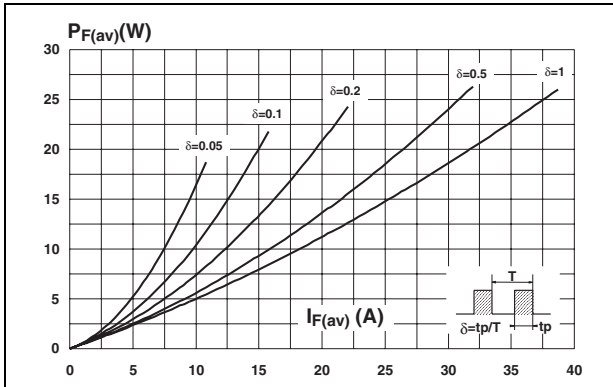


Figure 2. Average forward current vs. ambient temperature ($\delta = 0.5$, per diode)

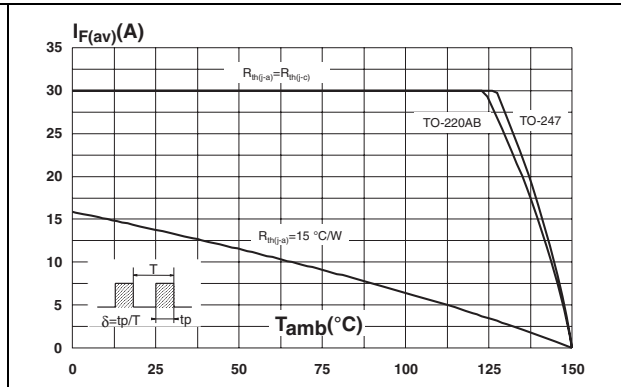


Figure 3. Normalized avalanche power derating vs. pulse duration

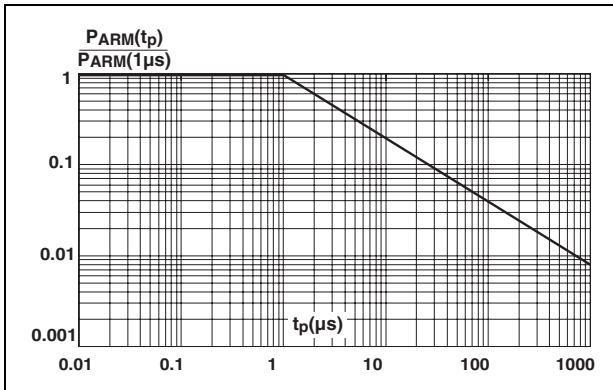


Figure 4. Normalized avalanche power derating vs. junction temperature

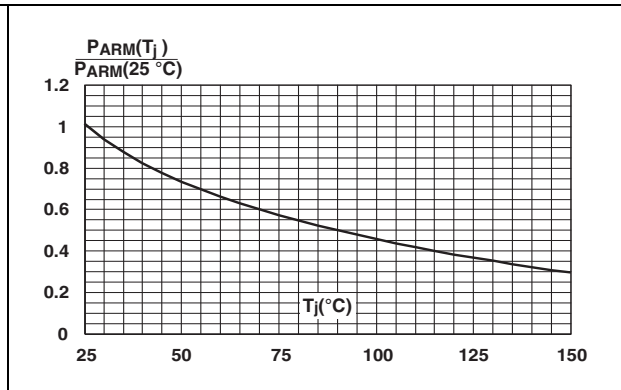


Figure 5. Non repetitive surge peak forward current vs. overload duration (max. values, per diode, TO-247)

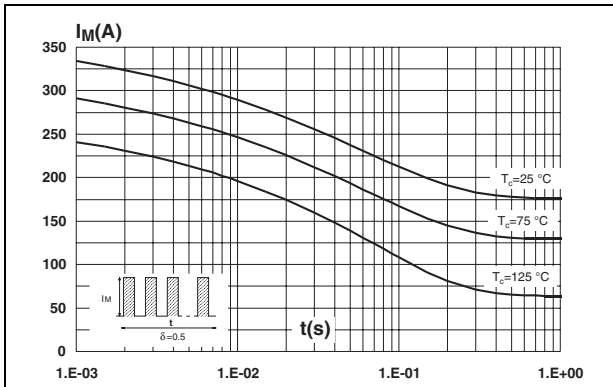


Figure 6. Non repetitive surge peak forward current vs. overload duration (max. values, per diode, TO-220AB)

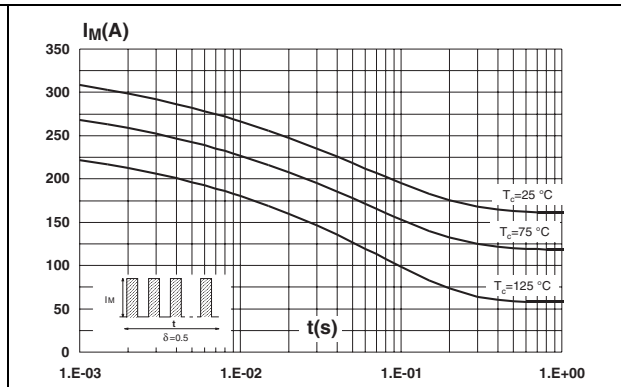


Figure 7. Relative variation of thermal impedance junction to case vs. pulse duration

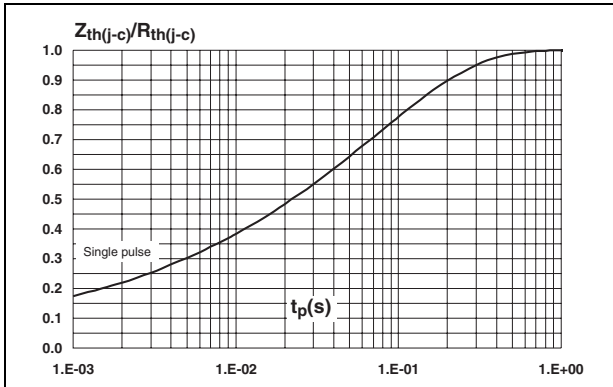


Figure 8. Reverse leakage current vs. reverse voltage applied (typical values, per diode)

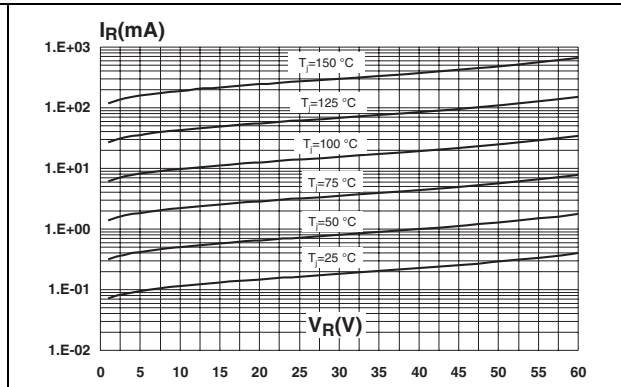


Figure 9. Junction capacitance vs. reverse voltage applied (typical values, per diode)

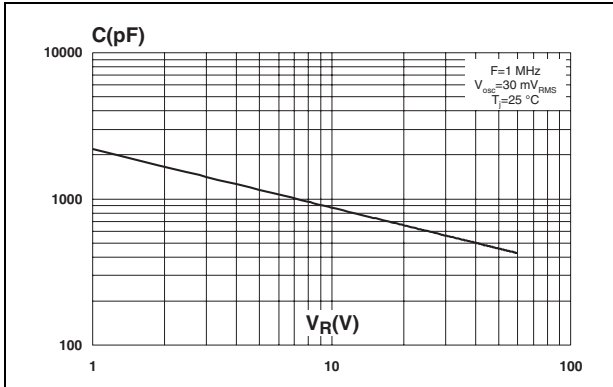
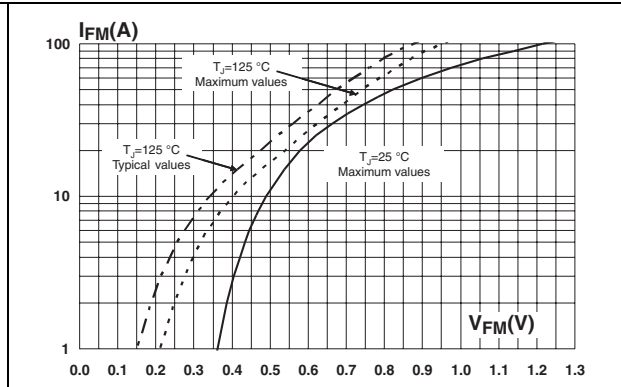


Figure 10. Forward voltage drop vs. forward current (per diode)



2 Package Information

- Epoxy meets UL94, V0
- Cooling method: convection
- Torque value:
 - TO-247 - 0.55 N·m recommended, 1.0 N·m maximum
 - TO-220AB - 0.4 to 0.6 N·m

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK[®] is an ST trademark.

Table 5. TO-247 dimensions

Ref.	Dimensions			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	4.85	5.15	0.191	0.203
D	2.20	2.60	0.086	0.102
E	0.40	0.80	0.015	0.031
F	1.00	1.40	0.039	0.055
F1	3.00 typ.		0.118 typ.	
F2	2.00 typ.		0.078 typ.	
F3	2.00	2.40	0.078	0.094
F4	3.00	3.40	0.118	0.133
G	10.90 typ.		0.429 typ.	
H	15.45	15.75	0.608	0.620
L	19.85	20.15	0.781	0.793
L1	3.70	4.30	0.145	0.169
L2	18.50 typ.		0.728 typ.	
L3	14.20	14.80	0.559	0.582
L4	34.60 typ.		1.362 typ.	
L5	5.50 typ.		0.216 typ.	
M	2.00	3.00	0.078	0.118
V	5° typ.		5° typ.	
V2	60° typ.		60° typ.	
Dia.	3.55	3.65	0.139	0.143

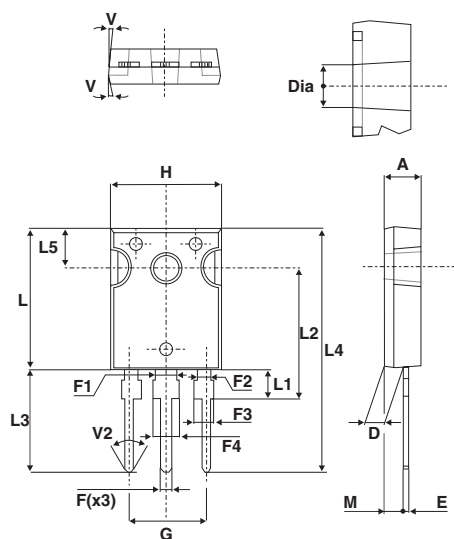


Table 6. TO-220AB dimensions

Ref.	Dimensions			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	4.40	4.60	0.173	0.181
C	1.23	1.32	0.048	0.051
D	2.40	2.72	0.094	0.107
E	0.49	0.70	0.019	0.027
F	0.61	0.88	0.024	0.034
F1	1.14	1.70	0.044	0.066
F2	1.14	1.70	0.044	0.066
G	4.95	5.15	0.194	0.202
G1	2.40	2.70	0.094	0.106
H2	10	10.40	0.393	0.409
L2	16.4 typ.		0.645 typ.	
L4	13	14	0.511	0.551
L5	2.65	2.95	0.104	0.116
L6	15.25	15.75	0.600	0.620
L7	6.20	6.60	0.244	0.259
L9	3.50	3.93	0.137	0.154
M	2.6 typ.		0.102 typ.	
Diam.	3.75	3.85	0.147	0.151

3 Ordering information

Table 7. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
STPS61L60CW	STPS61L60CW	TO-247	4.4 g	30	Tube
STPS61L60CT	STPS61L60CT	TO-220AB	2.23 g	30	Tube

4 Revision history

Table 8. Document revision history

Date	Revision	Changes
18-May-2009	1	Initial release

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